

## 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Low threshold voltage
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

### 3. Applications

- High-side load switch
- Battery management
- DC-to-DC conversion
- Switching circuits

## 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-12	V
V <sub>GS</sub>	gate-source voltage			-8	-	8	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-	-30.6	А
Static chara	cteristics			·			
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 25 °C		-	3.2	3.7	mΩ
	resistance	$V_{GS}$ = -2.5 V; I <sub>D</sub> = -15.9 A; T <sub>j</sub> = 25 °C		-	4.1	5.1	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



# 5. Pinning information

	. Pinning info	1		Orrest his south al
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	1 2 3 4	
2	S	source	_فـفـفــف_	P
3	S	source		
4	G	gate		
5	D	drain		
6	D	drain	للممحا	S 017aaa257
7	D	drain	8 7 6 5 MI DAK22 (SOT9002 1)	
8	D	drain	MLPAK33 (SOT8002-1)	

# 6. Ordering information

Table 3. Ordering information						
Type number     Package						
	Name	Description	Version			
PXP3R7-12QU		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1			

# 7. Marking

Table 4. Marking codes	
Type number	Marking code
PXP3R7-12QU	9AR

PXP3R7-12QU

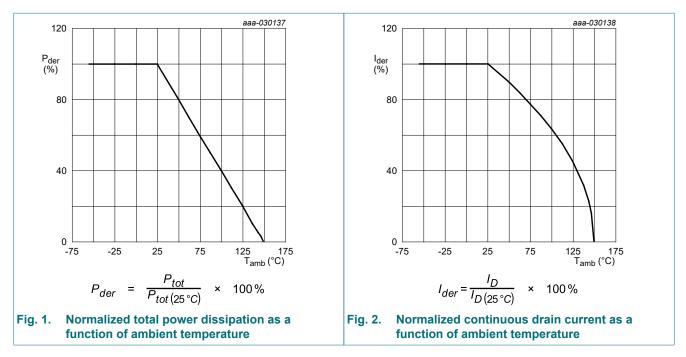
## 8. Limiting values

#### Table 5. Limiting values

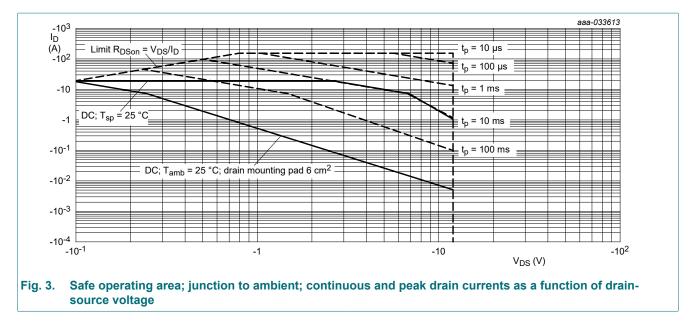
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-12	V
V <sub>GS</sub>	gate-source voltage			-8	8	V
I <sub>D</sub>	drain current	$V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s	[1]	-	-30.6	А
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-18.7	А
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 100 °C	[1]	-	-11.8	А
		V <sub>GS</sub> = -4.5 V; T <sub>sp</sub> = 25 °C		-	-98.6	А
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-154	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	4.8	W
		T <sub>amb</sub> = 25 °C	[1]	-	1.8	W
		T <sub>sp</sub> = 25 °C		-	50	W
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
Source-drai	n diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.7	А
		I contraction of the second				

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



#### 12 V, P-channel Trench MOSFET



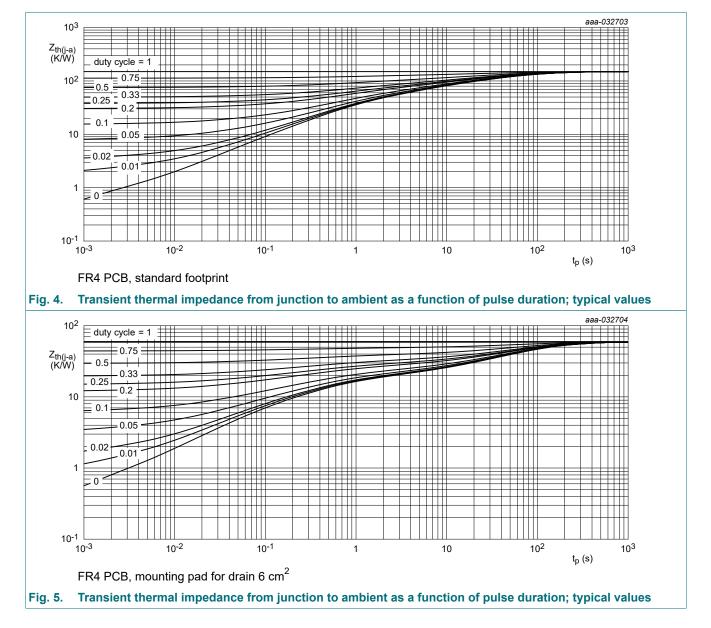
PXP3R7-12QU

## 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient		[1]	-	145	185	K/W
			[2]	-	55	70	K/W
		in free air; t ≤ 5 s	[2]	-	21	26	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	1.5	2.5	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

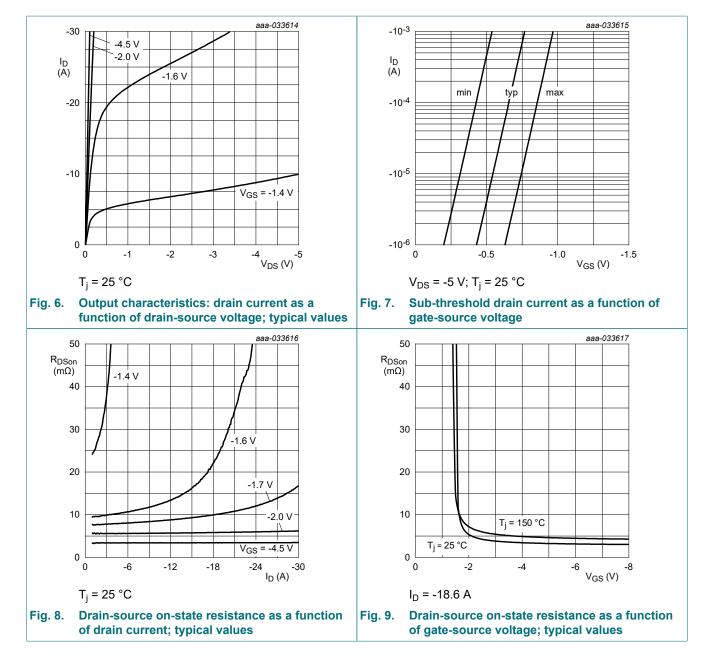
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



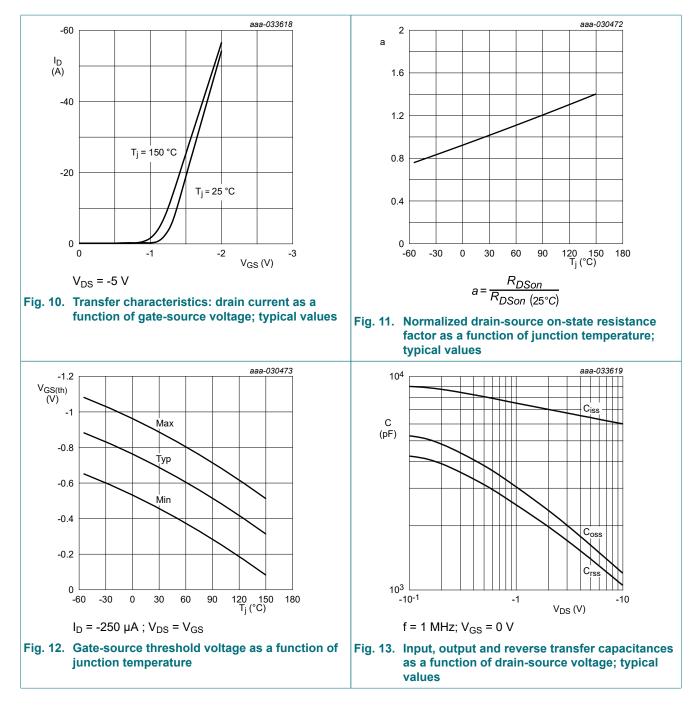
# **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = -250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-12	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-0.47	-0.7	-0.9	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = -12 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-1	μA
I <sub>GSS</sub> gate lea	gate leakage current	V <sub>GS</sub> = -8 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-100	nA
		V <sub>GS</sub> = 8 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 25 °C	-	3.2	3.7	mΩ
	resistance	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 150 °C	-	4.4	5.1	mΩ
		V <sub>GS</sub> = -2.5 V; I <sub>D</sub> = -15.9 A; T <sub>j</sub> = 25 °C	-	4.1	5.1	mΩ
		V <sub>GS</sub> = -1.8 V; I <sub>D</sub> = -4 A; T <sub>j</sub> = 25 °C	-	6.2	8.5	mΩ
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -18.6 A; T <sub>j</sub> = 25 °C	-	65	-	S
R <sub>G</sub>	gate resistance	f = 1 MHz	-	4.5	-	Ω
Dynamic ch	aracteristics					
Q <sub>G(tot)</sub>	total gate charge	V <sub>DS</sub> = -6 V; I <sub>D</sub> = -15.9 A; V <sub>GS</sub> = -4.5 V; T <sub>j</sub> = 25 °C	-	75	110	nC
Q <sub>GS</sub>	gate-source charge		-	9.8	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge		-	4.9	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	4.9	-	nC
Q <sub>GD</sub>	gate-drain charge		-	20.5	-	nC
V <sub>GSpl</sub>	gate-source plateau voltage	V <sub>DS</sub> = -6 V; I <sub>D</sub> = -15.9 A; T <sub>j</sub> = 25 °C	-	-1.5	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = -6 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	6500	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	1500	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	1300	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -6 V; I <sub>D</sub> = -15.9 A; V <sub>GS</sub> = -4.5 V;	-	8	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	33	-	ns
t <sub>d(off)</sub>	turn-off delay time	1	-	217	-	ns
t <sub>f</sub>	fall time	] [	-	177	-	ns
Source-drai	n diode		,			
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -1.7 A; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	-0.7	-1.2	V

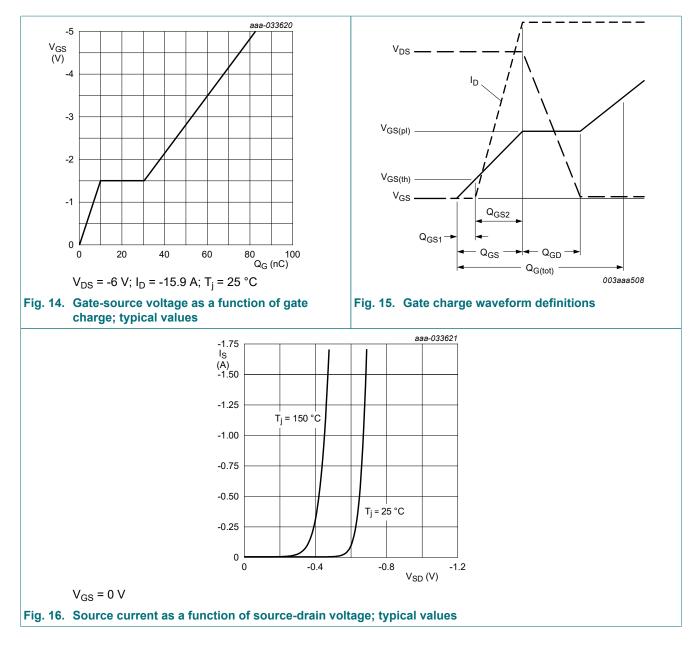
#### 12 V, P-channel Trench MOSFET



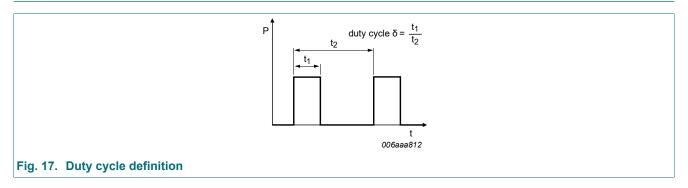
#### 12 V, P-channel Trench MOSFET



### 12 V, P-channel Trench MOSFET



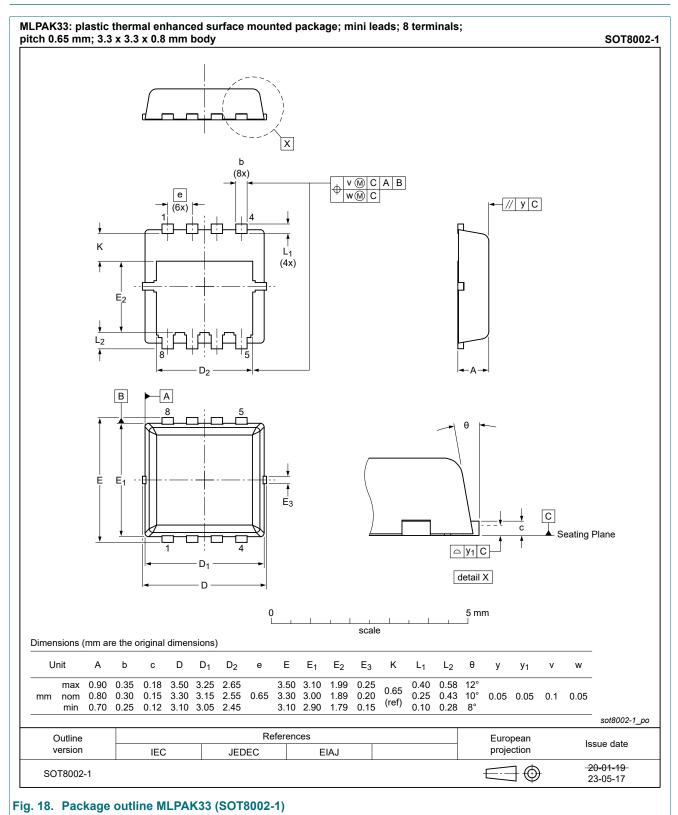
## **11. Test information**



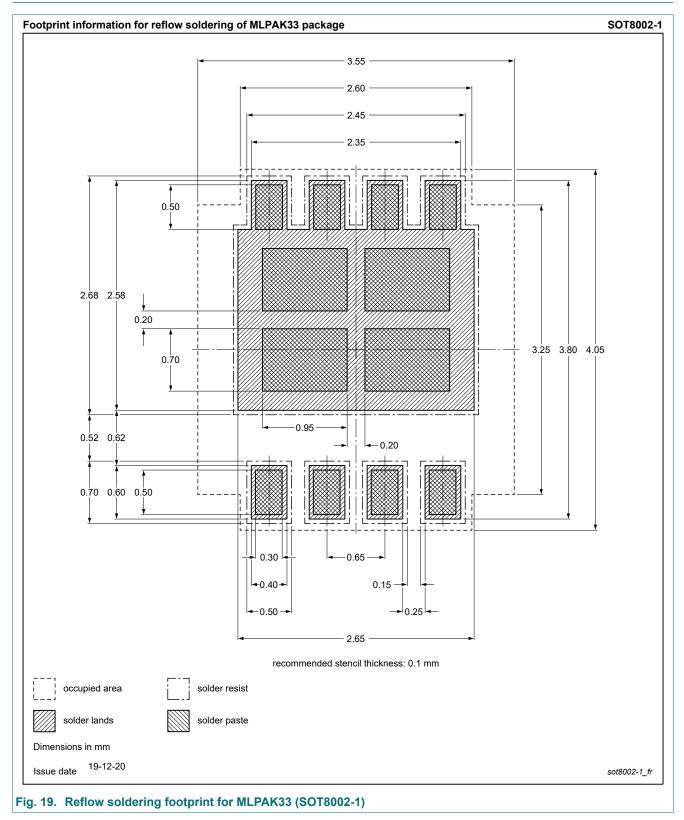
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## 12. Package outline



## 13. Soldering



# 14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PXP3R7-12QU v.2	20230731	Product data sheet	-	PXP3R7-12QU v.1			
Modifications:	Chapter "Package outline": drawing update						
PXP3R7-12QU v.1	20210906	Product data sheet	-	-			

PXP3R7-12QU

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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